

L Number	Hits	S arch Text	DB	Time stamp
1	26	"5462820"	USPAT; US-P PUB; EPO; JPO; DERWENT	2004/01/20 10:47
2	2	5462820.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/20 11:42
3	2	5462820.pn. and polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/20 11:35
4	1	"870771"	US-PGPUB	2004/01/20 11:35
5	1	"870771" and polymer	US-PGPUB	2004/01/20 11:35
6	1	5462820.pn. and binder	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/20 11:43
7	238	(ion adj conduct\$5) near2 (resin binder)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/20 11:44
8	153	((ion adj conduct\$5) near2 (resin binder)) not (li lithium)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/20 11:44
9	85	((ion adj conduct\$5) near2 (resin binder)) not (((ion adj conduct\$5) near2 (resin binder)) not (li lithium))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/20 11:53
10	2	"11262501"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/20 11:53
11	2	"11262502"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/01/20 11:56
12	74282	h01m\$.ipc.	JPO	2004/01/20 11:56
13	160	h01m\$.ipc. and (ion adj conducti\$4 adj polymer)	JPO	2004/01/20 11:59
14	0	jp11262501	JPO	2004/01/20 11:57
15	0	jp11262502	JPO	2004/01/20 11:57
16	0	jp011262502	JPO	2004/01/20 11:57
17	0	jp0110262502	JPO	2004/01/20 11:57

18	0	jp110262502	JP	2004/01/20 11:58
19	72	(h01m\$.ipc. and (i n adj c nducti\$4 adj p lym r)) not lectr de	JP	2004/01/20 11:58
20	88	(h01m\$.ipc. and (i n adj condu ti\$4 adj p lym r)) n t ((h01m\$.ipc. and (i n adj conducti\$4 adj polymer)) not electrode)	JPO	2004/01/20 11:58
21	40	h01m\$.ipc. and ((ion adj conducti\$4 adj polymer) near5 (film layer coating coat))	JPO	2004/01/20 12:01
22	1000	11262\$	JPO	2004/01/20 12:01
23	9	11262\$ and polymer	JPO	2004/01/20 12:03
24	2341	sato and shimizu	JPO	2004/01/20 12:05
25	45	(sato and shimizu) and h01m\$.ipc.	JPO	2004/01/20 12:04
26	4075	sato and shimizu	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/20 12:05
27	3644	(sato and shimizu) not electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/20 12:05
28	431	(sato and shimizu) not ((sato and shimizu) not electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/20 12:05
29	405	((sato and shimizu) not ((sato and shimizu) not electrode)) not ((sato and shimizu) and h01m\$.ipc.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/20 12:05
30	347	((sato and shimizu) not ((sato and shimizu) not electrode)) not ((sato and shimizu) and h01m\$.ipc.)) not polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/20 12:06
31	58	((sato and shimizu) not ((sato and shimizu) not electrode)) not ((sato and shimizu) and h01m\$.ipc.)) not (((sato and shimizu) not ((sato and shimizu) not electrode)) not ((sato and shimizu) and h01m\$.ipc.)) not polymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/20 12:08
32	1	2001-566754.NRAN.	DERWENT	2004/01/20 12:06
33	7	"1130662"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/20 12:08

34	1	2001-160091.NRAN.	DERWENT	2004/01/20 12:08
35	2	"08287951"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/20 12:09
36	3	"07235328"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/20 12:09
37	3	"05275077"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/20 12:09